

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	Grant of Security Interest
CONVEYING PARTY DATA	
Name	Execution Date
Semtech Corporation	10/02/2012
RECEIVING PARTY DATA	
Name:	Jefferies Finance LLC, as Collateral Agent
Street Address:	520 Madison Avenue
City:	New York
State/Country:	NEW YORK
Postal Code:	10022
PROPERTY NUMBERS Total: 4	
Property Type	Number
Patent Number:	5874938
Patent Number:	6175359
Patent Number:	6429850
Application Number:	13549017
CORRESPONDENCE DATA	
Fax Number:	2123548113
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	212-819-8200
Email:	iprecordations@whitecase.com
Correspondent Name:	Andrew Fessak/White & Case LLP
Address Line 1:	1155 Avenue of the Americas
Address Line 2:	Patent and Trademark Department
Address Line 4:	New York, NEW YORK 10036
ATTORNEY DOCKET NUMBER:	1155735-0023-GALAXY
NAME OF SUBMITTER:	Andrew Fessak

OP \$160.00 5874938

Total Attachments: 4

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GRANT OF SECURITY INTEREST
IN UNITED STATES PATENTS

FOR GOOD AND VALUABLE CONSIDERATION, receipt and sufficiency of which are hereby acknowledged, Semtech Corporation, a Delaware corporation (the "Grantor") with principal offices at 200 Flynn Road, Camarillo, California 93012, hereby grants to Jefferies Finance LLC, as Collateral Agent, with principal offices at 520 Madison Avenue, New York, NY 10022 (the "Grantee"), for the ratable benefit of the Secured Creditors, a security interest in (i) all of the Grantor's rights, title and interest in, to and under the United States patents and patent applications (the "Patents") set forth on Schedule A attached hereto, in each case together with (ii) all Proceeds (as such term is defined in the Guaranty and Collateral Agreement referred to below).

THIS GRANT is made to secure the satisfactory performance and payment of all the Secured Obligations of the Grantor, as such term is defined in the Guaranty and Collateral Agreement among the Grantor, the other grantors from time to time party thereto and the Grantee, dated as of March 20, 2012 (as amended, modified, restated and/or supplemented from time to time, the "Guaranty and Collateral Agreement").

This Grant has been granted in conjunction with the security interest granted to the Grantee under the Guaranty and Collateral Agreement. The rights and remedies of the Grantee with respect to the security interest granted herein are as set forth in the Guaranty and Collateral Agreement, all terms and provisions of which are incorporated herein by reference. In the event that any provisions of this Grant are deemed to conflict with the Guaranty and Collateral Agreement, the provisions of the Guaranty and Collateral Agreement shall govern.

This Grant shall be construed in accordance with and governed by the laws of the State of New York (without regard to conflicts of law principles).

[Remainder of this page intentionally left blank; signature page follows]

IN WITNESS WHEREOF, the undersigned have executed this Grant as of the 2nd day of October, 2012.

SEMTECH CORPORATION, Grantor

By 

Name: Emeka Chukwu

Title: Senior Vice President, Finance and
Chief Financial Officer

JEFFERIES FINANCE LLC, as Collateral Agent and
Grantee

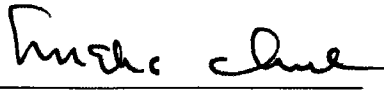
By _____

Name:

Title:

IN WITNESS WHEREOF, the undersigned have executed this Grant as of the 2nd day of October, 2012.

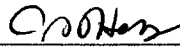
SEMTECH CORPORATION, Grantor

By 

Name: Emeka Chukwu

Title: Senior Vice President, Finance and
Chief Financial Officer

JEFFERIES FINANCE LLC, as Collateral Agent and
Grantee

By 

Name: E.J. Hess

Title: Managing Director

<u>PATENT</u>	<u>PATENT/APPLICATION NO.</u>	<u>ISSUE/FILE DATE</u>
Pointing Device with Reduced Component Count	Patent No. 5,874,938	Issued February 23, 1999
Pointing Device with Reduced Component Count (Divisional)	Patent No. 6,175,359	Issued January 16, 2001
Pointing Device with Reduced Component Count (Continuation)	Patent No. 6,429,850	Issued August 6, 2002
Wireless & Capacitive Body Proximity Sensor System	Application No. 13/549,017	Filed July 13, 2012